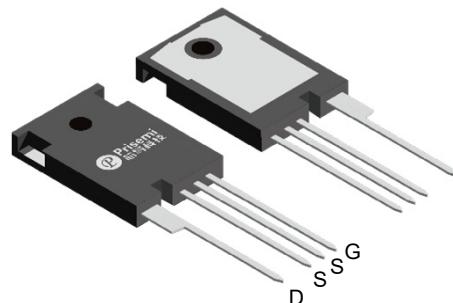


Description

MOSFET Product Summary		
V _{DS} (V)	R _{DS(on)} (mΩ)	I _D (A)
650	45@ V _{GS} = 15V	51

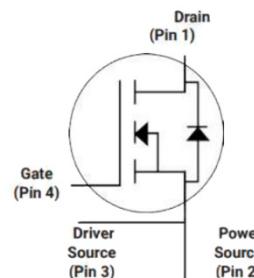

TO-247-4L

Feature

- High Blocking Voltage with Low On-Resistance
- High Frequency Operation
- Low on-resistance
- Fast intrinsic diode with low reverse recovery
- 100% avalanche tested

Applications

- Solar Inverters
- Switch Mode Power Supplies
- UPS
- Battery Chargers


Schematic diagram

Absolute maximum rating@25°C

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSmax}	650	V
Gate-Source Voltage (dynamic), T _{surge} <100ns	V _{GSmax}	-8/+19	V
Gate-Source Voltage (static)	V _{GSoP}	-4/+15	V
Continuous Drain Current @ V _{GS} =15V	T _C =25°C	51	A
	T _C =100°C	36	
Pulsed Drain Current	I _{D(pulse)}	120	A
Avalanche Energy @ V _{DD} =100V, V _{GS} =15V, L=1mH	E _{AS}	313	mJ
Avalanche Peak Current @ V _{DD} =100V, V _{GS} =15V, L=1mH	I _{AV}	25	A
Power Dissipation	P _D	200	W
Operating Junction and Storage Temperature	T _J , T _{STG}	-55 to +175	°C

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Case	R _{θJC}	-	0.61	0.75	°C/W

Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Units
Statistic Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 100\mu A$		650	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 5mA$	$T_J = 25^\circ C$	1.8	2.7	3.6	V
			$T_J = 150^\circ C$	-	2.0	-	
			$T_J = 175^\circ C$	-	1.9	-	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 650V, V_{GS} = 0V$		0.0	1.0	50	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = 15V, V_{DS} = 0V$		0.0	1.0	200	nA
		$V_{GS} = -4V, V_{DS} = 0V$		-200	-1.0	0.0	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 15V, I_D = 20A$	$T_J = 25^\circ C$	-	45	60	mΩ
			$T_J = 150^\circ C$	-	50	-	
			$T_J = 175^\circ C$	-	55	-	
		$V_{GS} = 13V, I_D = 20A$		-	57	-	
Transconductance	g_{fs}	$V_{DS} = 20V, I_D = 20A$	$T_J = 25^\circ C$	-	15	-	S
			$T_J = 150^\circ C$	-	14	-	
			$T_J = 175^\circ C$	-	14	-	
Dynamic Characteristics							
Input Capacitance	C_{iss}	$V_{DS} = 400V, V_{GS} = 0V, f = 1MHz$		-	1650	-	pF
Output Capacitance	C_{oss}			-	142	-	
Reverse Transfer Capacitance	C_{rss}			-	8.0	-	
C_{oss} Stored Energy	E_{oss}			-	14	-	μJ
Total Gate Charge	Q_g	$V_{DS} = 400V, I_D = 20A, V_{GS} = -4V/+15V$		-	79	-	nC
Gate-Source Charge	Q_{gs}			-	22	-	
Gate-Drain Charge	Q_{gd}			-	31	-	
Internal Gate Input Resistance	$R_{G(int)}$	$f=1MHz, I_D = 0A$		-	3.0	-	Ω
Turn-On Switching Energy	E_{on}	$V_{DS} = 400V, I_D = 20A$		-	91	-	μJ
Turn-Off Switching Energy	E_{off}		$V_{GS} = -4V/+15V, R_{G(ext)} = 2\Omega, L=100\mu H$	-	13	-	
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 400V, I_D = 20A$		-	13	-	ns
Turn-on Rise Time	t_r		$V_{GS} = -4V/+15V, R_{G(ext)} = 2\Omega, L=100\mu H$	-	17	-	
Turn-Off Delay Time	$t_{d(off)}$			-	24	-	
Turn-Off Fall Time	t_f			-	8.0	-	
Reverse Diode Characteristics							
Diode Forward Voltage	V_{SD}	$V_{GS} = -4V, I_{SD} = 10A$	$T_J = 25^\circ C$	-	4.1	-	V
			$T_J = 150^\circ C$	-	3.7	-	
			$T_J = 175^\circ C$	-	3.6	-	
		$V_{GS} = -4V, I_{SD} = 20A$	$T_J = 25^\circ C$	-	4.7	-	
			$T_J = 150^\circ C$	-	4.2	-	
			$T_J = 175^\circ C$	-	4.1	-	
Continuous Diode Forward Current	I_s	$V_{GS} = -4V$		-	-	36	A
Reverse Recovery Time	t_{rr}	$V_{GS} = -4V, I_{SD} = 20A$		-	13	-	ns
Reverse Recovery Charge	Q_{rr}		$V_R = 400V, dif/dt = 3300A/\mu s$	-	155	-	
Peak Reverse Recovery Current	I_{rrm}			-	22	-	A

Typical Characteristics

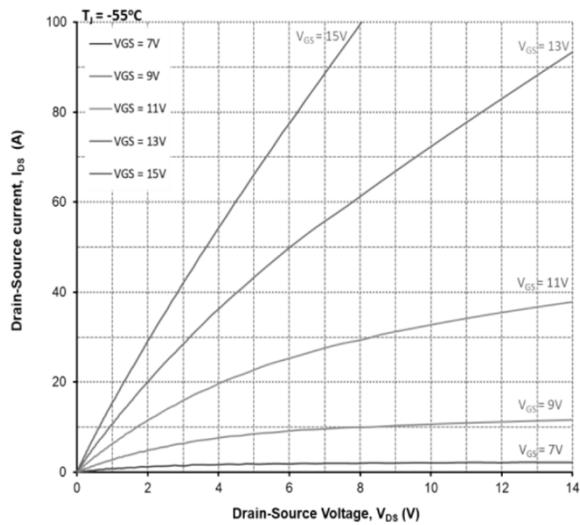
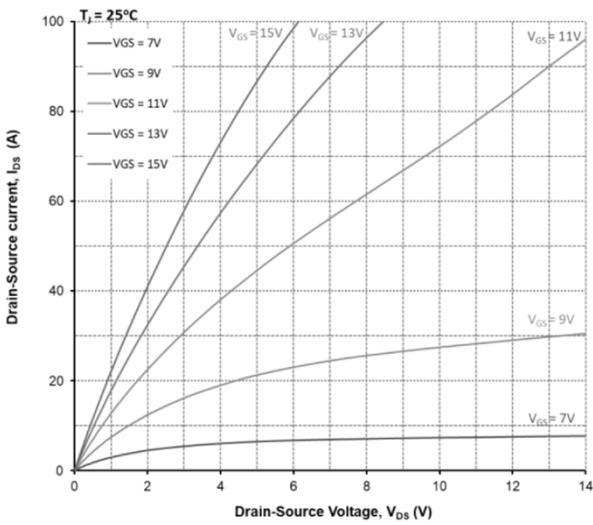
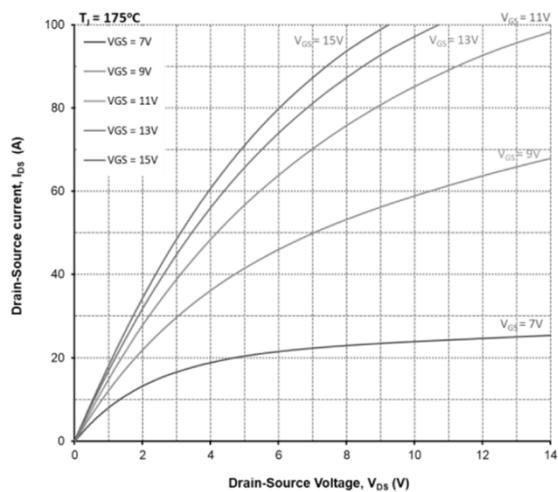
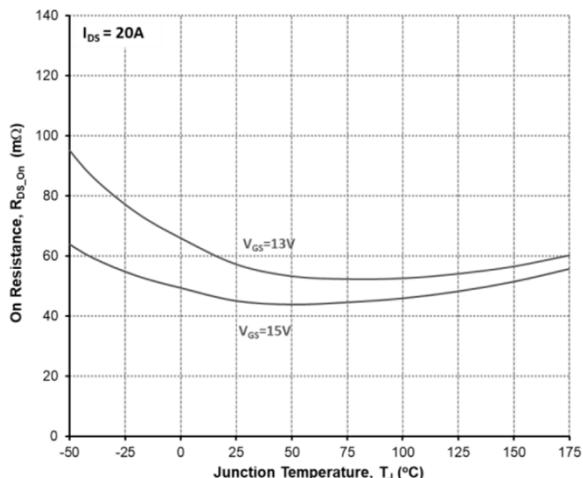
Figure 1. Output Characteristics, $T_J = -55^\circ\text{C}$ Figure 2. Output Characteristics, $T_J = 25^\circ\text{C}$ Figure 3. Output Characteristics, $T_J = 175^\circ\text{C}$ 

Figure 4. On-Resistance vs. Temperature

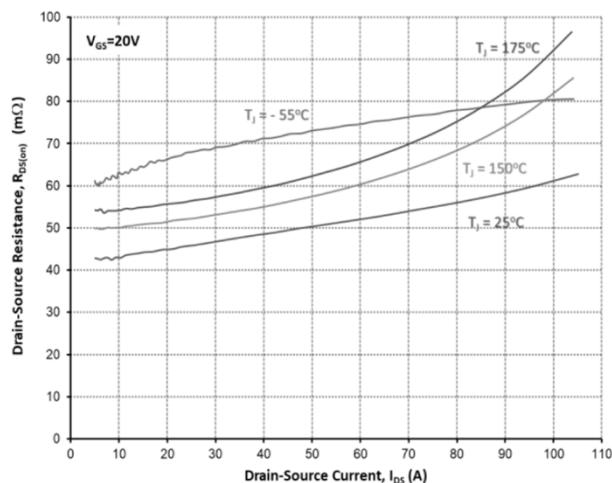


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

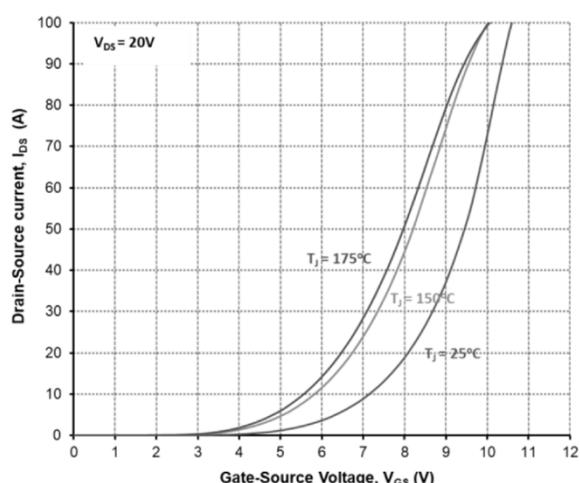


Figure 6. Transfer Characteristic For Various Junction Temperatures

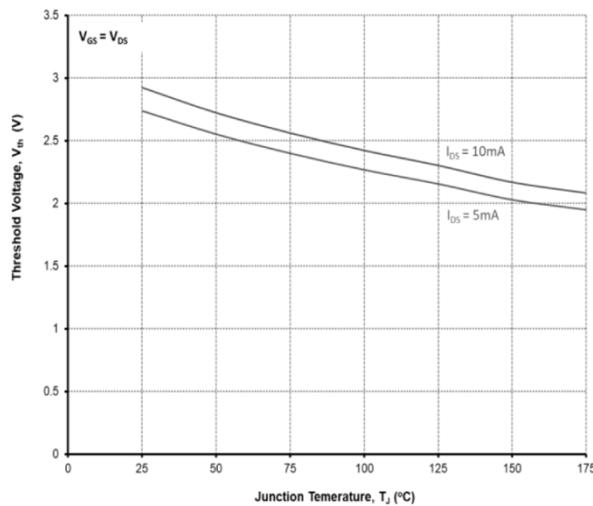


Figure 7. Threshold Voltage vs. Temperature

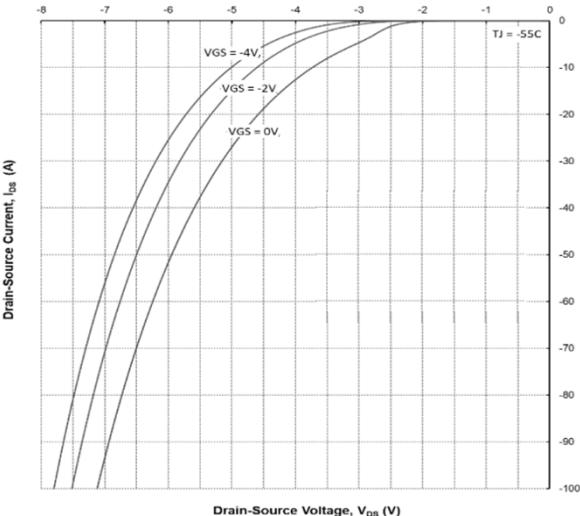


Figure 8. Body Diode Characteristics @ -55°C

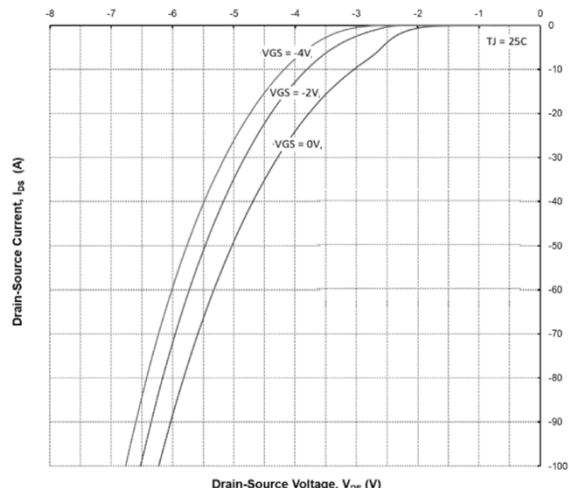


Figure 9. Body Diode Characteristics @ 25°C

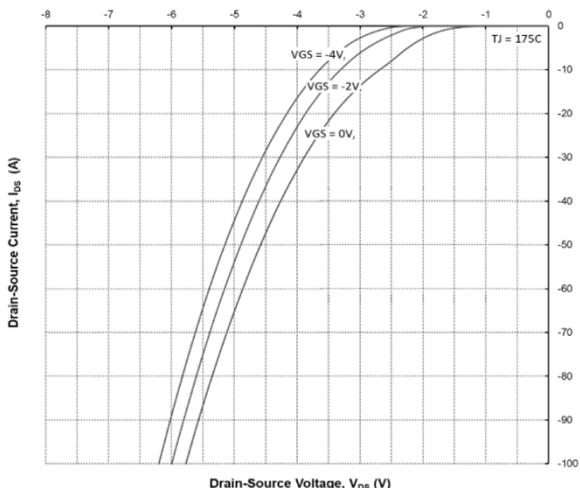


Figure 10. Body Diode Characteristics @ 175°C

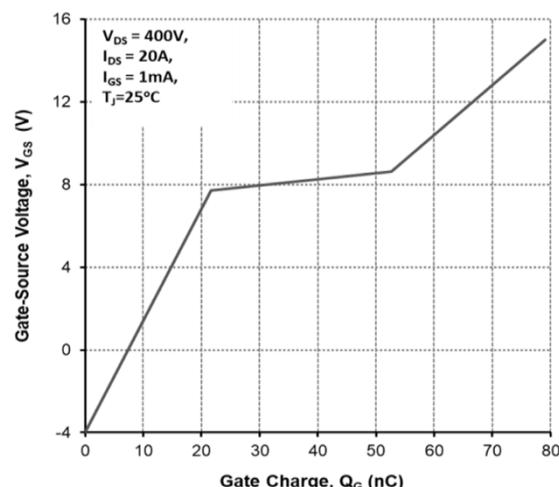


Figure 11. Gate Charge Characteristics

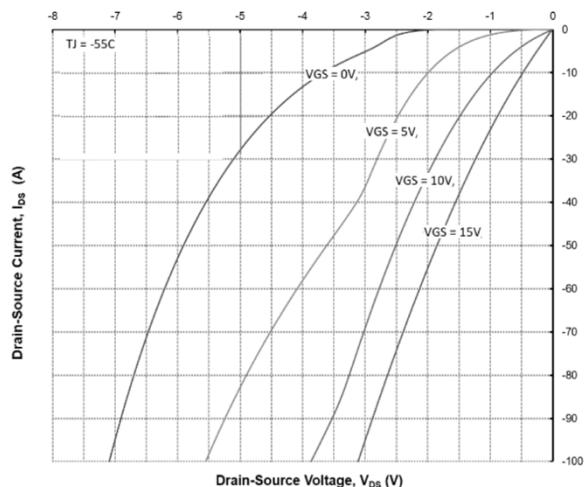


Figure 12. 3rd Quadrant Characteristics @ -55°C

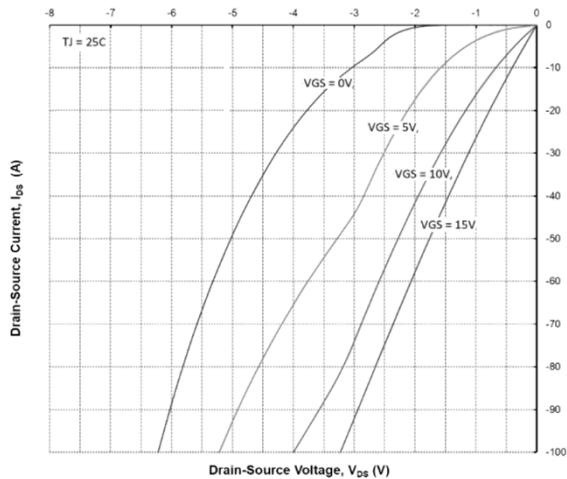
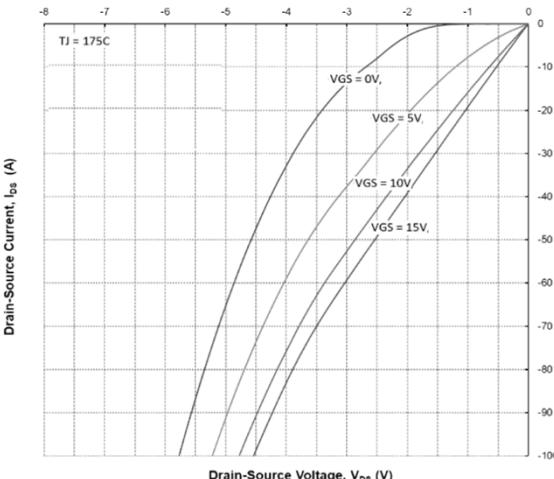
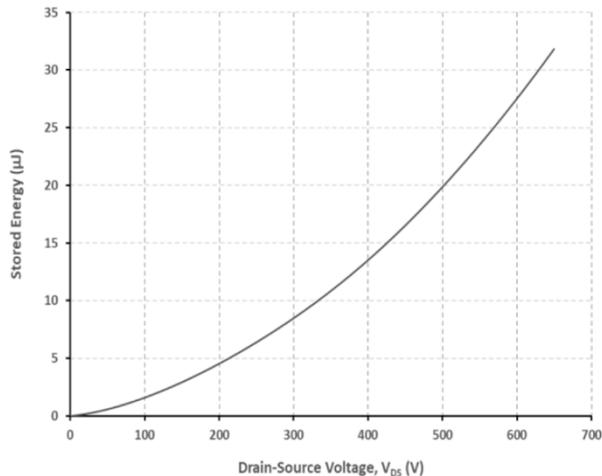
Figure 13. 3rd Quadrant Characteristics @ 25°CFigure 14. 3rd Quadrant Characteristics @ 175°C

Figure 15. Output Capacitor Stored Energy

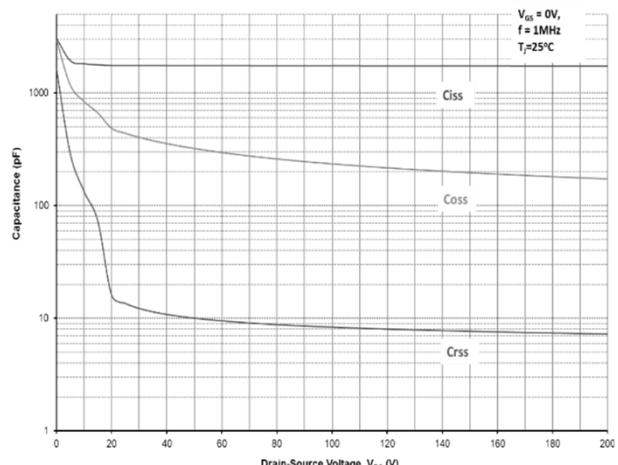


Figure 16. Capacitances vs. Drain-Source Voltage (0-200V)

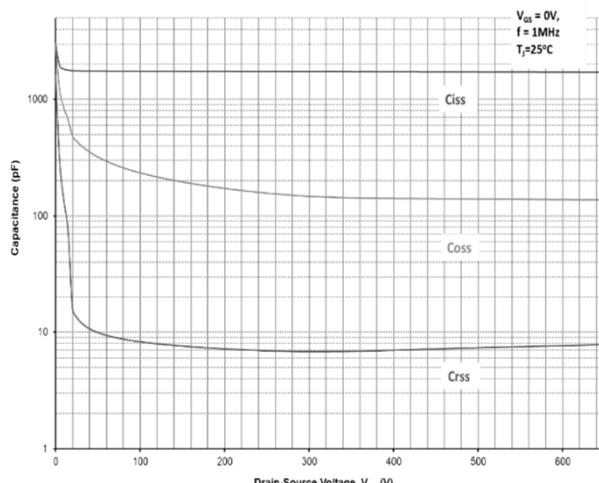


Figure 17. Capacitances vs. Drain-Source Voltage (0-650V)

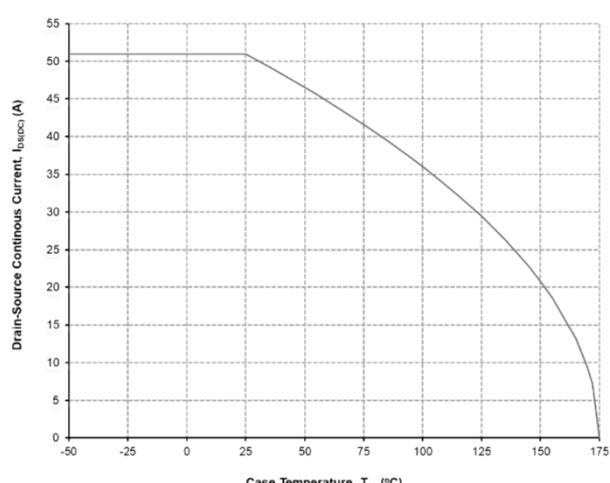
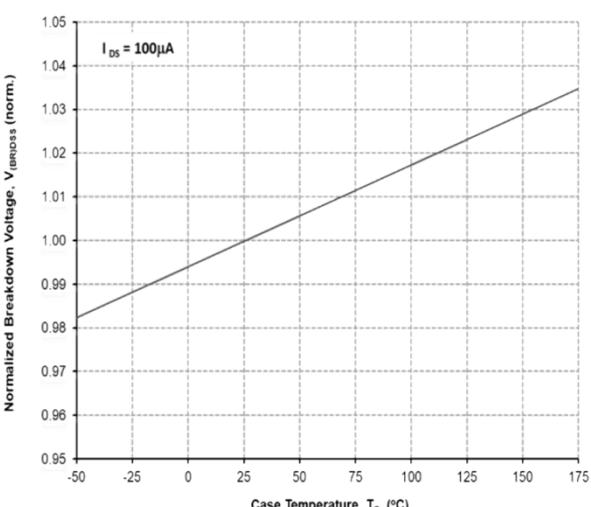
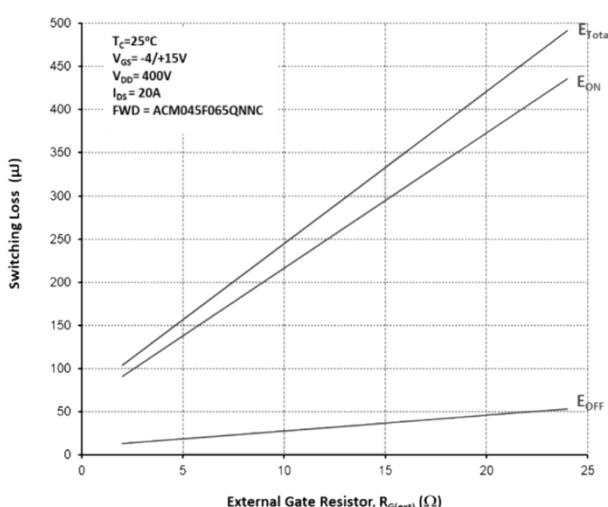
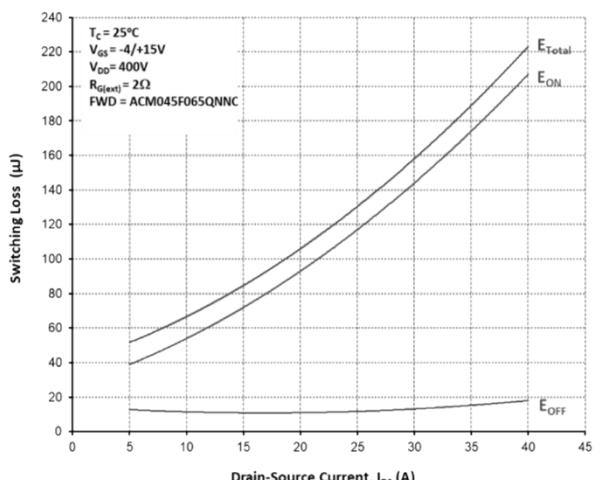
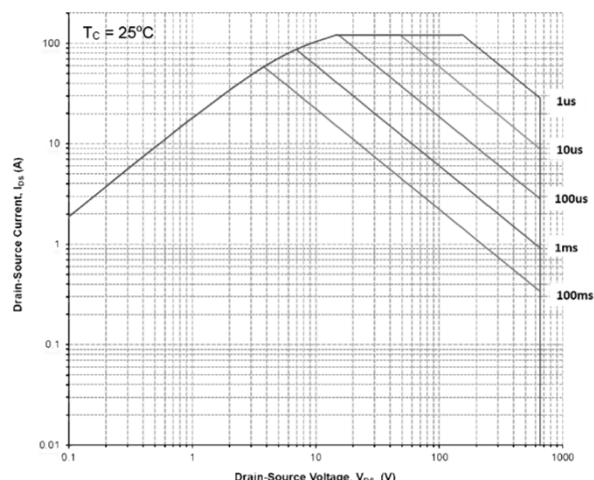
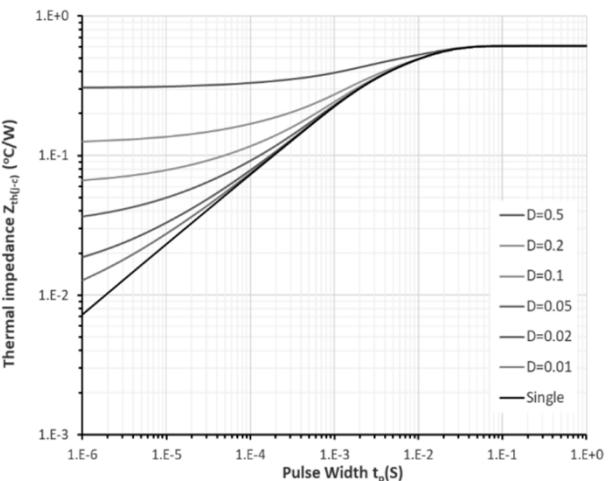
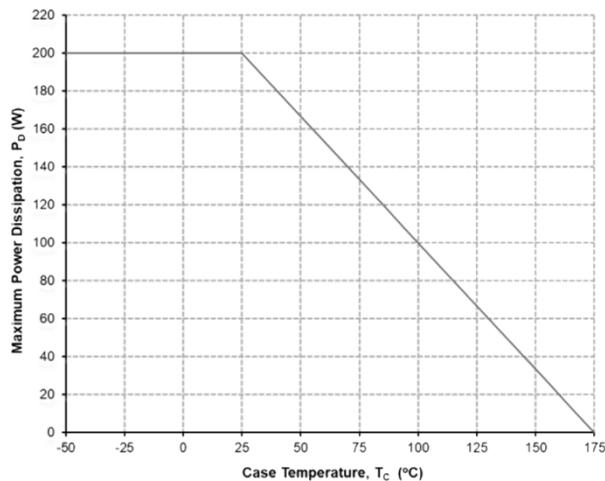
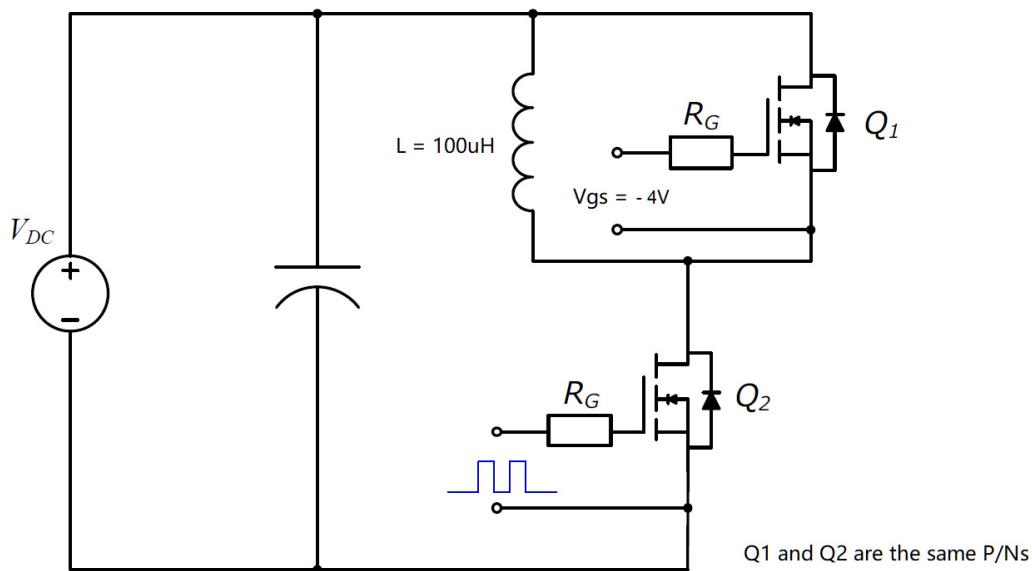
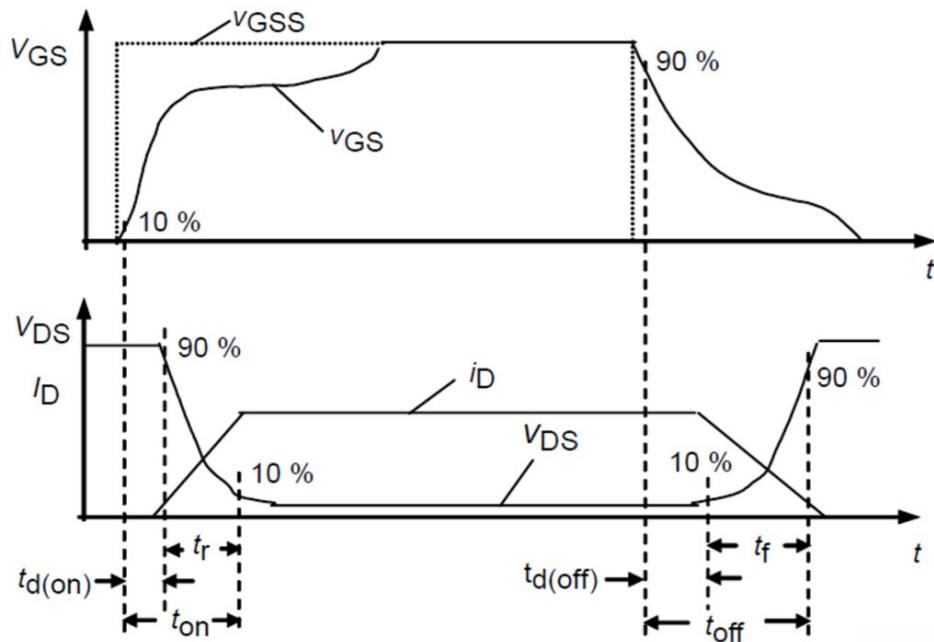


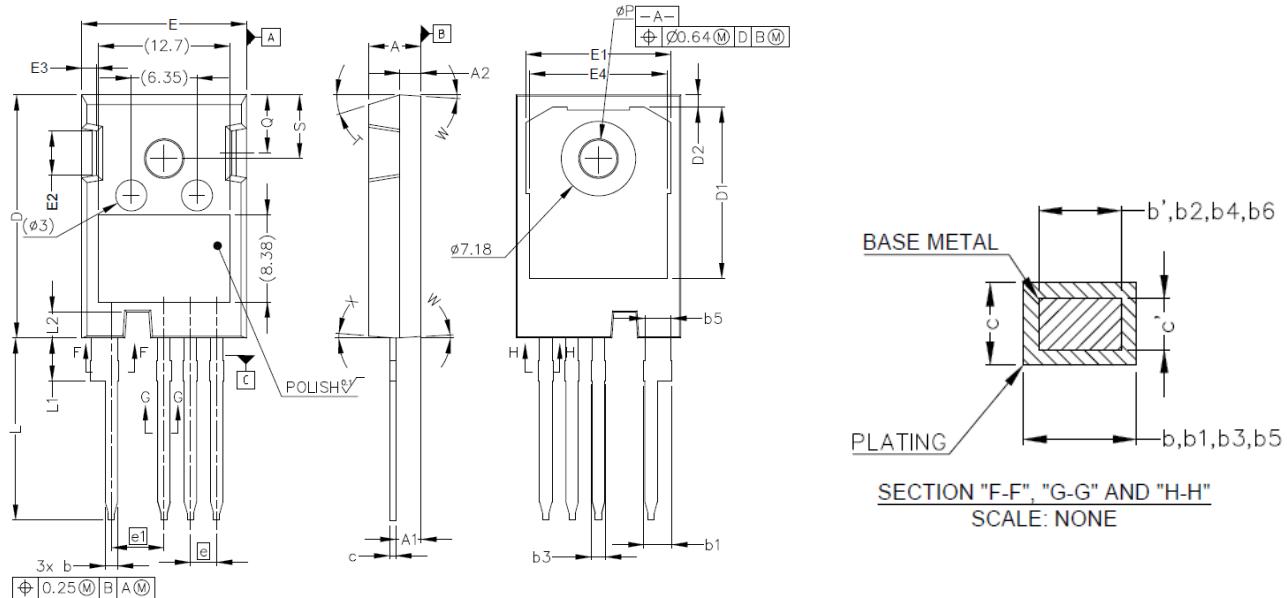
Figure 18. Continuous Drain Current Derating vs. Case Temperature



Switching Times Definition and Test Circuit



Product dimension (TO-247-4L)



Dim	Millimeters		Inches		Dim	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	4.83	5.21	0.190	0.205	E1	13.10	14.15	0.516	0.557
A1	2.29	2.54	0.090	0.100	E2	3.68	5.10	0.145	0.201
A2	1.91	2.16	0.075	0.085	E3	1.00	1.90	0.039	0.075
b'	1.07	1.28	0.042	0.050	E4	12.38	13.43	0.487	0.529
b	1.07	1.33	0.042	0.052	e	2.54 BSC		0.100 BSC	
b1	2.39	2.94	0.094	0.116	e1	5.08 BSC		0.200 BSC	
b2	2.39	2.84	0.094	0.112	N	4.00		0.157	
b3	1.07	1.60	0.042	0.063	L	17.31	17.82	0.681	0.702
b4	1.07	1.50	0.042	0.059	L1	3.97	4.37	0.156	0.172
b5	2.39	2.69	0.094	0.106	L2	2.35	2.65	0.093	0.104
b6	2.39	2.64	0.094	0.104	φP	3.51	3.65	0.138	0.144
c'	0.55	0.65	0.022	0.026	Q	5.49	6.00	0.216	0.236
c	0.55	0.68	0.022	0.027	S	6.04	6.30	0.238	0.248
D	23.30	23.60	0.917	0.929	T	17.5° Ref.		17.5° Ref.	
D1	16.25	17.65	0.640	0.695	W	3.5° Ref.		3.5° Ref.	
D2	0.95	1.25	0.037	0.049	X	4° Ref.		4° Ref.	
E	15.75	16.13	0.620	0.635					

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